Solderless Breadboard (840 Tie Points) with Binding Posts

195

122

V_1 V_2

Electronic, Circuit Educational & Testing Devices
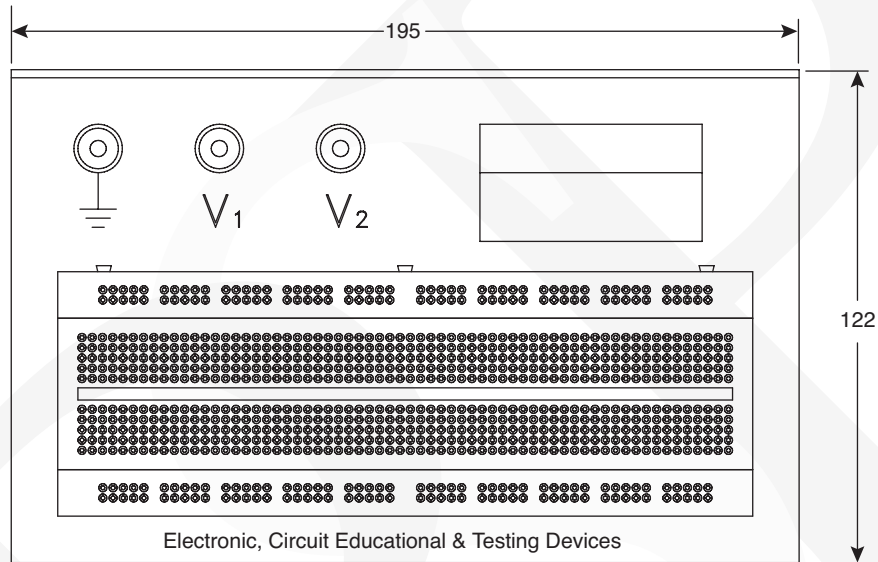
Dimensions: mm

Breadboard Specifications:

- 840 Tie points
- 14-pin IC capacity: 9
- 128-5 Connected terminals
- 8-25 Connected bus
- 3 Binding posts

Mouser Stock No.	Contents
383-R840B	Breadboard only
383-R21BKSW	Breadboard and Jump Wire Kit (383-SWS350)

383-R840B, 383-R21BKSW

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

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[383-R840B](#) [383-R21BKSW](#)